



# ACCELERATING ASIC VERIFICATION USING FPGA-BASED PROTOTYPING AND EMULATION: A DEEP DIVE INTO INDUSTRY PRACTICE

Author: Archana Salla – [LinkedIn Profile](#)

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## ABSTARCT

The demand for high-performance, low-power ASICs across AI, data center, mobile, and automotive domains has driven rapid innovation in System-on-Chip (SoC) design. However, traditional verification methods are increasingly inadequate due to the scale and complexity of modern chips. Field Programmable Gate Arrays (FPGAs) are now a cornerstone of pre-silicon validation, enabling emulation and prototyping of SoCs before tape-out. This paper explores the role of FPGAs in ASIC testing and SoC prototyping, with case studies from NVIDIA, AMD, Meta, and Apple. It evaluates industry-leading tools from Cadence, Synopsys, and Siemens, and presents comparative data analysis on time-to-market reduction, bug detection efficiency, and cost impact. The paper also highlights leaders in FPGAs, SoCs, and hardware emulation, underscoring trends like cloud-hosted prototyping and AI-assisted verification.

## INTRODUCTION

Modern SoCs integrate complex subsystems like multi-core CPUs, GPUs, AI engines, interconnects, and high-speed I/Os. As a result, verifying these chips before fabrication is both critical and time sensitive. A single design error can cause a multi-million-dollar loss due to silicon re-spins or delayed market entry.

FPGAs provide a reprogrammable, high-performance platform that enables the emulation and prototyping of ASICs at near-real-time speeds. Companies such as NVIDIA, AMD, Meta, Qualcomm, and Apple leverage FPGA-based solutions to:

- Validate RTL early in the design cycle
- Enable software and firmware development pre-silicon
- Identify and fix bugs in system-level interactions
- Reduce ASIC time-to-market by 30–60%

This paper presents an overview of how FPGAs are used in SoC prototyping and emulation, along with detailed data analysis, vendor landscape, and emerging trends.

## CASE STUDY

### 1. The Role of FPGAs in ASIC Verification

Modern chips can feature:

- 10 billion transistors
- 50+ IP cores (CPU, GPU, NPU, PCIe, USB, DDR, etc.)
- Multiple clock and power domains
- Real-time and embedded OS stacks

Traditional RTL simulation (at 1–10 Hz) is inadequate for validating full-system behavior, especially with real workloads. FPGAs provide hardware-accelerated platforms running at 10–500 MHz.

#### Emulation vs. Prototyping

Feature	Emulation	Prototyping
Speed	1-100Mhz	10-500MHz
Debug visibility	High	Medium
Software execution	Supported	Ideal for full stack
RTL correlation	Cycle-accurate	Close, but less than emulation
Recompilation time	Low	Higher
Product examples	Palladium, Veloce	Protium, HAPS

### 2. Industry-Leading Companies in Emulation, Prototyping, and SoC Development.

#### 2.1 Leading Prototyping and Emulation Vendors

Company	Tools/Platforms	Specialty
Cadence	Palladium Z2, Protium X1, X2	Unified flow for emulation and prototyping
Synopsys	ZeBu Server 5, HAPS-100	High throughput prototyping
Siemens EDA	Veloce Strato , Primo	Cloud-based emulation
Aldec	HES-DVM	Embedded SoC prototyping

#### 2.2 Leading FPGA Vendors

Company	Products	Specialty
AMD (Xilinx)	Versal AI Core, Zynq MPSoC	Adaptive compute, FPGA, ML acceleration
Intel	Agilex, Stratix	Data center, edge, 5G
Lattice	CrossLink, Certus	Low-power edge devices
Microchip	PolarFire SoC	Secure, radiation tolerant FPGAs

#### 2.3 Leading SoC Innovators

Company	Initiatives	Specialty
NVIDIA	Grace Hopper, Orin, Blackwell	AI Compute, GPU-CPU SoCs
Apple	M1,M2,M4	Consumer SoC(macOS/iOS)
AMD	Ryzen, EPYC, MI300	CPU-GPU synergy, HPC
Meta	MTIA, AI ASICs. Tofino	Interference, networking
Google	TPU, Coral	AI accelerators

### 3. Real-World Adoption

#### 3.1 NVIDIA's Hybrid Emulation-Prototyping Flow

NVIDIA combines Cadence Palladium Z2 and Protium X1 for multi-phase SoC testing.

- Palladium: Runs RTL validation and functional debug
- Protium: Executes drivers and CUDA software stack at higher speed
- Uses a unified compile flow to move designs between platforms efficiently

Metric	Simulation Only	Cadence Flow
Firmware start	Post silicon	Pre silicon (6-9 months early)
Re-spin risk	High	Reduced ~80%
Linux boot test	Not feasible	< 30 minutes

#### 3.2 Meta: AI and Network ASIC Validation

- Uses custom FPGA clusters (100s of boards)
- Streams real datacenter workloads into SoC RTL
- Validates AI inference behavior, DRAM traffic, and PCIe
- Result: 50–60% reduction in ASIC bring-up time

#### 3.3 AMD and Apple

- AMD uses HAPS and Palladium for validating APUs with shared memory controllers.
- Apple uses Protium to validate full macOS/iOS stacks on A-series and M-series SoCs months before silicon arrives.

### 4. Quantitative Analysis and Performance Metrics

#### 4.1 Platform Comparison

Category	RTL Simulation	Emulation	FPGA Prototyping
Speed	< 1Hz	1-100 MHz	10-3000 MHz
Compile time	Short	~6-12 hours	1-3 days
Debug capability	Excellent	Very good	Moderate
Software readiness	Not feasible	Good	Excellent
Energy Cost	Low	Medium	High

## 4.2 Time-to-Market Acceleration

Traditional RTL	18-24 months
Emulation	12-15 months
Prototyping	9-12 months
Hybrid (Eg : Cadence)	6-9 months

## 4.3 Cost Savings Estimate

Category	Estimated Value per Chip
Re-spin avoidance	\$2M-5M
Software readiness	6-9 months faster
Debug engineering time	30-40% saved

## 5. Technical Challenges and Solutions

Challenge	Vendor Solution
Design partitioning for FPGAs	Cadence/Synopsys partitioning tools
Debug signal observability	Waveform tracers, embedded ILAs
High memory Interface modeling	PCIe and DDR real-time co-sim
Toolchain unification	Cadence unified compile across platforms

## 6. Future Outlook

- 4Cloud FPGA Prototyping: Siemens and Cadence launching cloud-hosted prototypes
- AI-Powered Verification: Bug classification, path tracing, and coverage automation
- FOGA Integration: Xilinx Versal and Intel Agilex blending FPGA with SoC and AI compute
- Dynamic partial reconfiguration: Runtime swapping of SoC partitions on prototype

## 7. Conclusion

FPGAs are reshaping the way SoCs are validated before tape-out. Companies like NVIDIA, Meta, AMD, and Apple are now relying on FPGA-based emulation and prototyping to streamline their silicon journeys. By reducing test cycles, avoiding costly re-spins, and enabling early software integration, FPGA platforms are becoming a critical part of the silicon design toolchain.

As SoCs grow in complexity, hybrid verification flows combining emulation, prototyping, and cloud deployment—led by platforms from Cadence, Synopsys, and Siemens—will define the next era of chip design and validation.

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